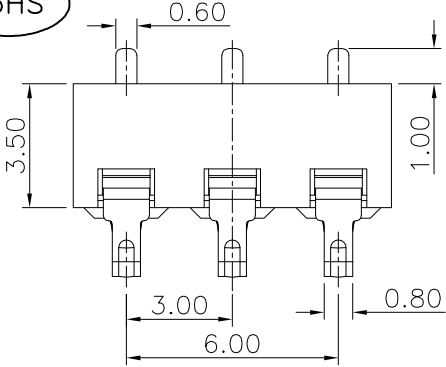
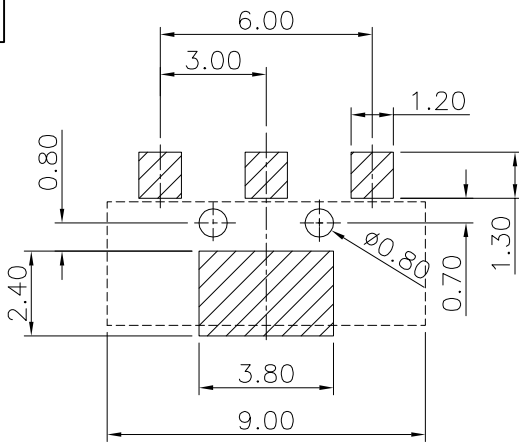
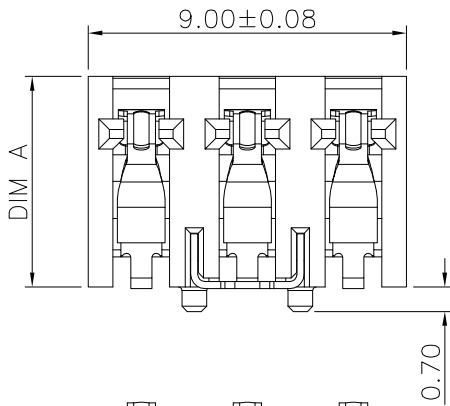
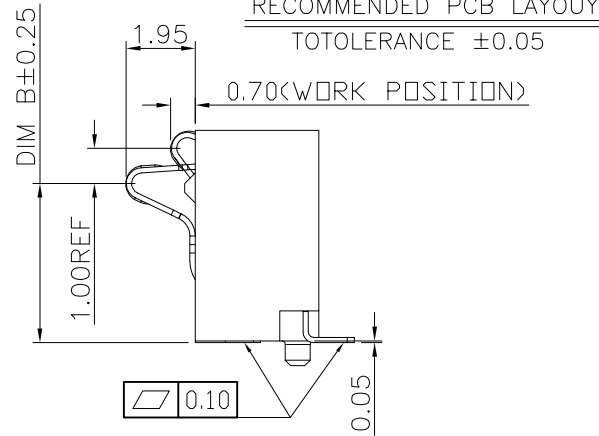
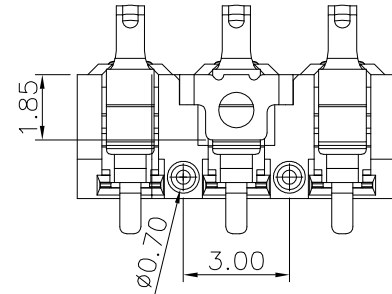


	1	2	3	4	5	6	7	8							
A	The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements														
B	RoHS 														
C				RECOMMENDED PCB LAYOUT TOLERANCE ±0.05											
D															
E				NOTE: 1.MATERIAL SPECIFICATION: 1-1.HOUSING:HIGH TEMPRATURE THERMOPLASTIC,UL 94V-0 1-2.CONTACTS:COPPER ALLOY MAITNG AEEA Au PLATED. 1-3.PAD: COPPER ALLOY SN PLATED. 2.ELECTRICAL PERFORMANCE: 2-1.CURRENT RATING:1.0A 2-2.RATED VOLTAGE: 12 V DC 2-3.CONTACT RESISTANCE: 30m Ohm MAX. 2-4.INSULATION RESISTANCE: 1000MΩ MIN 2-5.DIELECTRIC WITHSTANDING VOLTAGE: 250V AC MIN. 3.ENVIRONMENTAL PERFORMANCE: OPERATING TEMPERATURE: -20°C~+85°C. WLBTf9-03 2 X X X 005 PLATING: ———— 1-G/F 2-AU 3U" 5-AU 15U" 6-AU 30U" COLOUR: A:Black 1:DIM A=5.40,DIM B=3.90 2:DIM A=5.70,DIM B=4.20 3:DIM A=6.00,DIM B=4.50 4:DIM A=6.20,DIM B=4.70											
F															
G															
H	REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Teconology Co., Ltd			
	A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13	WLBTf9-032XXX005					
					0.0±0.35	X°REF±6°	DESIGNER	Ding_bo	21.01.13	TITLE: 内焊式电池座 PH3.0 有柱 (H5.4~6.2)					
				UNIT:mm	0.00±0.25	X'±3°	DRAWN	Ou_jian	21.01.13	REV: A0 SHEET: 1/1					
				SIZE: A4	0.000±0.10	X°X' ±2°									
	1	2	3	4	5	6	7	8							